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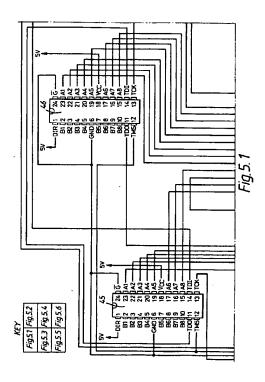
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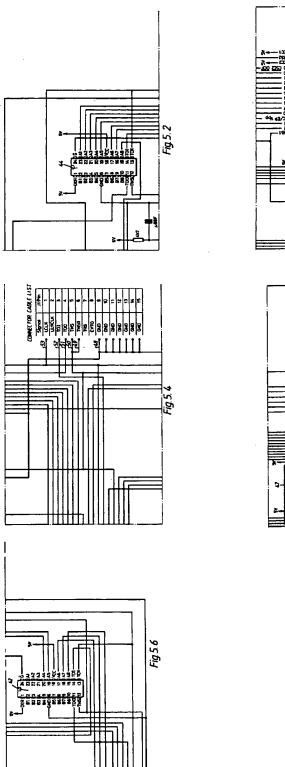
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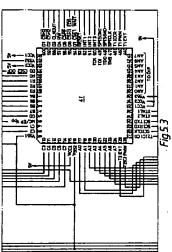
- (54) Method of testing interconnections between integrated circuits in a circuit.
- A method of testing the interconnections between integrated circuits in a circuit uses latches, respectively connected to the terminals of the integrated circuit, which are connectable in series as a shift register so that a test pattern of bits can be entered into the latches. The pattern of bits is transmitted through the interconnections to other latches and then shifted out of the circuit along the shift register. Discrepancies between the input and output patterns indicate malfunctioning interconnections. The method is extended to apply to a microprocessor in the circuit, the microprocessor having a program that enables it to use its RAM to act as the latches connected to the other integrated circuits. The program may be stored in on-chip memory in the microprocessor and where that memory is RAM, EPROM or EEPROM it may be erased therefrom after successful testing of the circuit.

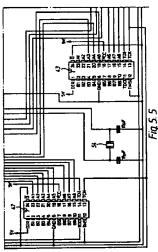


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The present invention relates to the testing of circuit boards, in particular to the boundary scan testing of a circuit board including a microprocessor.

Manufacturers of electronic circuits commonly produce their circuits in the form of printed circuit boards having mounted on them a plurality of integrated circuits as well as other components. The components are interconnected by conductors or metallic tracks printed on the board with electrical contact between the leads or pins of the components and the tracks made using solder joints. The interconnections may be imperfect and may display short- or open-circuit connections that are erroneous, the errors possibly arising from faults of either the solder joints or the tracks.

Once a circuit board is completed it would, of course, be possible to operate the circuit as a method of testing it but with the complexity of many such boards it would be both difficult and time consuming to test it thoroughly to check that all interconnections were correctly made. Boundary scan testing is a method of testing the interconnections between integrated circuits on a circuit board which enables the test to be carried out more quickly. A system of boundary scan testing is defined by IEEE standard 11491.1-1990 "Standard Test Access Port and Boundary Scan Architecture" also known as JTAG. To support JTAG boundary scan testing an integrated circuit will have specially provided for each of a number of its pins a boundary scan cell, for example, an input latch, an output latch or both of those or a combined input-output latch, for transmitting and receiving signals via the particular pin. In addition a boundary scan cell may include a control latch. The latches may each comprise a shift register latch and a shadow latch. The shift register latches can be joined with others, from the same and other boundary scan cells, to form a long shift register joining up all the input and/or output terminals of the integrated circuits. The cells can therefore be loaded serially with data supplied to an dedicated test data input pin on each integrated circuit. Data already in the shift register latches is shifted out via a dedicated test data output pin of the integrated circuit when the shift register is operated. From time to time data can be transferred between the shift register latches and their corresponding shadow latches.

In a circuit having more than one JTAG integrated circuit the shift registers of each integrated circuit can be joined serially to form one long shift register known as the scan path.

To perform a test of the interconnections between integrated circuits on a circuit board test data appropriately interspersed with control data is fed along the scan path and is loaded into the input and output latches of the integrated circuits. Each boundary scan cell will either be an input cell or an output cell depending on the value loaded in its control latch if it has one; if a cell has no control latch then it will have been built as an input cell or an output cell. Next, each output cell transmits the test data held in its output latch over the interconnections via its pin and each input latch receives test data from the interconnections via its pin and stores it. The resulting pattern of data in the latches can then be shifted out along the scan path for analysis to find out whether the interconnections are functioning correctly. Note that the data held in the shadow latches actually determine whether the boundary scan cells are inputs or outputs and the values to be output on the cells' pins are directly responsive to data supplied to the pins.

Usually the test patterns are generated by a computer which also analyses the resulting patterns. Normally the computer is given a description of the integrated circuits on the scan path, for example which cells have input latches and which have output latches, and a description of the interconnections on the board between the pins. From those descriptions the computer generates a number of test patterns, and after running the test the resulting patterns are analysed to see whether the circuit board has the described interconnections and, if not, to indicate in what way it might be faulty.

Boundary scan testing does provide a quick and reliable method of testing a circuit board; however it does require that the integrated circuits are constructed to include the necessary hardware; this includes not only the latches described above but the means to join them in a shift register and the means responsive to the necessary control signals.

Boundary scan testing is at its simplest and most effective when all the integrated circuits on a circuit board support it. If only some of the integrated circuits support it, then there are a number of things that can be done. The manufacturer of the integrated circuits can redesign the integrated circuits to include the hardware to support boundary scan testing; this takes some time, increases the silicon areas of the devices and hence their cost, and means that the new integrated circuits will not be compatible with the old ones and hence cannot directly replace the old ones since dedicated control pins and test data pins must be provided on the new ones. The manufacturer of the circuit board can add buffers that do support boundary scan testing between the integrated circuits that do not and the rest of the circuit but that increases cost and may affect the performance and timing of the circuit, and will introduce further interconnections that cannot be tested. As a last resort the corrections to the non-supporting integrated circuits can be ignored by the test, so reducing the coverage of the testing; the effects of that can to some extent be reduced by more lengthy and elaborate boundary scan test procedures, such as those described by Robinson and Deshages in a paper entitled "Interconnect Testing of Boards with Partial Boundary Scan" published by Gen Rad, Inc., of 300 Baker Avenue, Concord, MA, USA.

The disadvantages of these approaches are increased when the non-supporting integrated circuit is a microprocessor, for example a microcontroller, since such devices are usually the centre of functionality of any circuit in which they are included and consequently are connected to many of the other components.

Addition of the necessary JTAG hardware to a microcontroller can involve a considerable amount of work due to the complexity, type and number of input and output pins normally associated with them. Consequently, there is a reluctance to modify existing microcontroller designs to incorporate this feature.

It is an object of the present invention to provide a method of boundary scan testing a circuit, which includes a microprocessor that overcomes at least the difficulties described above.

According to the present invention there is provided a method of testing interconnections of a circuit having a plurality of integrated circuits,

at least some of the integrated circuits including

storage elements respectively associated with some of the terminals of those integrated circuits and means for joining the storage elements into at least one shift register chain,

the method including

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entering an initial test pattern of bits serially into the storage elements along the at least one shift register chain,

transferring certain of the bits of the initial test pattern from the storage elements into which they were entered, via the terminals and interconnections, to others of the storage elements,

retrieving the resulting pattern of bits serially from the storage elements along the at least one shift register chain, and

comparing the initial test pattern and resulting pattern to derive information about the interconnections, characterised in that

at least one of the plurality of integrated circuits is a microprocessor, there being stored in the circuit a test program which causes the microprocessor to perform a number of operations including

entering serially into the microprocessor part of the initial test pattern of bits and storing it in a memory, reading certain of the bits stored in the memory and producing corresponding output signals on terminals of the microprocessor connected to particular interconnections,

reading bits via particular interconnections at terminals of the microprocessor and storing the received bits in the memory, and

producing as an output from the microprocessor in serial form the received bits stored in the memory, so as to enable interconnections connected to terminals of the microprocessor to be tested.

The JTAG standard will now be described with reference to Figures 1, 2 and 3, followed by a description of a method of boundary scan testing a circuit board including a microprocessor, by way of example only. Reference will be made to the accompanying drawings, of which:-

FIGURE 1 is a circuit diagram of a circuit having three integrated circuits, all of which support boundary scan testing according to the JTAG standard;

FIGURE 2 is a diagram of an integrated circuit that supports boundary scan testing according to the JTAG standard;

FIGURE 3 is a state diagram for the test access port controller of Figure 2;

FIGURE 4 is a block diagram of one example of a microcontroller, and

FIGURE 5 is a diagram of a circuit including the microcontroller of Figure 4 that can be arranged to provide for boundary scan testing.

Figure 1 is a circuit diagram of a circuit having three integrated circuits 21,22, 23 all of which support JTAG boundary scan testing. Each integrated circuit has twenty pins 1-20 of which 1 and 20 are connected respectively to test mode select (TMS) and test clock (TCK) signal lines of JTAG bus, pins 10 and 11 are connected to the power supply, and application pins 3-9 and 12-18 are connected via various of the interconnections 25,26,27,28 to pins of others of the integrated circuits 21,22,23 or to terminals 24. For each of the pins 3-9 and 12-18 there is provided in the integrated circuit a boundary scan cell 29 having a combined input/output latch and a control latch. The boundary scan cells of all the integrated circuits are on a scan path 30 which starts at the terminal TDI, enters integrated circuit 21 at pin 2, passing through the boundary scan cells of that integrated circuit, and then leaves via pin 19 continuing through the integrated circuits 21,22 in a similar way in turn and finishing at terminal TDO. The scan path 30 can operate as a shift register driven by clock signals TCK

To test, for example, the interconnects 26 between the pins 12-18 of the integrated circuit 21 and the pins 3-9 of the integrated circuit 22, test data and interspersed control data is passed along the scan path 30, under the control of the signals on the TMS and TCK lines, into the input and output latches of the boundary scan cells 29. The input and output latches of the cells for pins 12-18 of the integrated circuit 21 are set up to be outputs and those for pins 3-9 of the integrated circuit 22 set up to be inputs. The important values of the test

data are those provided for the pins 12 to 18 of the integrated circuit 21 since it is these that are transferred across to the input latches of the integrated circuit 22, once all the data has been shifted in along the scan path. The data latched across are subsequently shifted out and analysed to check whether the interconnections 26 are all functioning correctly.

As a particular example, a test pattern might be LOW in all of the output latches for pins 12 to 18 except for a HIGH in the latch for pin 15. In the diagram it can be seen that if there were no fault a HIGH would be latched across to the input latch of pin 8 of the integrated circuit 22, the others of pins 3-9 receiving LOWs. If, for example, the interconnect from pin 15 to pin 8 was shorted to that from pin 14 to pin 4, then a HIGH would be received at the latch for pin 4, assuming that the latch for pin 15 was able to drive those interconnections HIGH while the latch for pin 14 was trying to drive them LOW. This extra HIGH in the resulting pattern shifted out along the scan path 30 would be detected by the computer performing the test which would produce an output indicating the nature of the fault detected.

It is clear that to test fully the interconnections for open and short circuits many operations of shifting in data, latching across and shifting out will be required. Test patterns are normally generated by the computer running the test under the control of software, such as the ASSET system of Texas Instruments Incorporated. More complicated interconnects than the one pin to one pin interconnects 26, for example the interconnects 27, can also be tested. Interconnects to terminals 24 could be tested by connecting them to other integrated circuits supporting JTAG off the circuit board under test, but included in the scan path.

Figure 2 is a diagram of an integrated circuit 39 that supports JTAG similar to those of Figure 1. In addition to boundary scan cells 29 on the scan path 30, the application pins 31 and pins 2,19 to connect to the scan path 30, pins 1,20 to receive the control signals, TMS, TCK and pins 10,11 to connect to the power supply, Figure 2 shows application circuitry 32, a test access port (TAP) controller 33, a bypass register 34, an instruction register 35, multiplexers 36,37 and a tristate latch 38. In the JTAG standard the bypass register and the set of boundary scan cells are known as data registers. In a full implementation of the standard there are other data registers provided but their operation is not relevant to the present invention and they will not be described.

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The application circuitry provides the normal functions of the integrated circuit when it is not in test mode. During those times it communicates freely with other components via the application pins 31 unhindered by the latches of the boundary scan cells. Note that in practice it may be required that the inputs and outputs of the application circuitry are latched and in that case the latches of the boundary scan cells could be used for that purpose.

The bypass register 34 and the instruction register are alternative scan paths to the boundary scan cells through the integrated circuit 39. Multiplexers 36 and 37 recombine those paths into a single one and latch 38 simply increases the length of each path by one step. The test access port controller is responsive to the TCK and TMS signals of the test bus and also to the value stored in the instruction register; it controls the operation of the rest of the test logic.

The bypass register 34 and the instruction register 35 like the boundary scan cells not only have latches which form a shift register when data is scanned through them but also latches shadowing those latches to and from which values can be transferred from time to time.

Figure 3 shows a state diagram for the test access port controller 33 of Figure 2, which conforms to the JTAG standard. The test access port controller examines the TMS signal at each positive going edge of TCK and changes to a new state depending on the value of TMS. This is shown in the diagram by arrows labelled 1 and 0 indicating the values of the TMS signal. The two parts of the diagram enclosed in dotted rectangles are for manipulating respectively a data register and the instruction register and are marked DR-SCAN 40 and IR-SCAN 39. The particular data register manipulated depends on the value held in the instruction register. It should be noted, then, that the selection of the scan path change through the integrated circuit 39 involves both the control signals, TMS and TCK, and the value in the instruction register 35. Moving around the state diagram allows boundary scan tests such as those described above to be carried out.

A full description of the functions of these states can be found in the JTAG standard. Some functions are not implemented in the device described below and only a brief description of the relevant states will be given.

The TEST-LOGIC-RESET state is the state on power up. In this state the test logic is inactive and the integrated circuit 39 performs its normal function using the application circuitry 32.

The RUN-TEST/IDLE state is used in the full standard for some special test functions; those are not implemented in the device described below but the state is provided to allow the states to change in the standard way in response to the TMS and TCK signals.

The SELECT-DR-SCAN and SELECT-IR SCAN states perform no function other than allowing other states to be reached from them.

In the CAPTURE-IR state the instruction register is loaded with a 10000001 pattern and is sent along the scan path. If the TEST-LOGIC-RESET state has been passed through since the last scan operation, the latch

38 which drives the TDO (test data output) pin 19 is enabled to output a LOW or zero, otherwise it is enabled to output the same as that which it was outputting the last time it was enabled.

In the SHIFT-IR state data is advanced through the instruction register, one step per cycle of TCK, from the TDI (test data input) pin 2 to the TDO pin 19. The 10000001 pattern in the register in the CAPTURE-IR state is shifted out and can be used to confirm that the instruction register is connected in the scan path.

EXIT1-IR and EXIT2-IR perform no operation; they allow the shifting operation to be ended.

PAUSE-IR performs no operation; the test access port controller 33 can be held in this state to allow the shifting operation to be suspended for a period of time.

In the state UPDATE-IR the value in the shift register latches of the instruction register are transferred to the shadow latches.

The functions of the states for manipulating the data registers depend on the particular register to be manipulated. They are as follows:-

CAPTURE-DR; the data register selected by the value in the instruction register is placed on the scan path, and the latch 38 that drives the TDO pin 19 is enabled in a similar manner as it is by the CAPTURE-IR instruction, except that when the bypass register is selected the latch 38 is enabled to output a low or zero level. In the case of the boundary scan cells it is during this state that the values present on the input pins and received by the shadow input latches from other boundary scan cells via the interconnects 26,27 are latched, along with data held in the other shadow latches, into the shift register latches.

In the SHIFT-DR state data held in the shift register latches of the selected register is shifted through the integrated circuit 39 from the TDI pin 2 to the TDO pin 19 one bit per cycle of TCK. In the case of the data register the data shifted will include control data as well as test data. In the case of the bypass register bits of the data are shifted through the integrated circuit rapidly since the register is only one bit long. This register is used, for example, when it is desired to use the boundary scan cells of other integrated circuits but not those of the particular integrated circuit.

The EXIT-DR, EXIT2-DR and PAUSE-DR states have similar functions to the corresponding IR states. In the UPDATE-DR state the latches shadowing the shift register latches are updated from those latches. In the case of the boundary scan cells the control data latches and the output latches are given their new val-

ues.

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Thus to perform the test of interconnects such as the interconnect 26,27 described above it is necessary to pass through the IR-SCAN state 39 once to shift into the instruction register an instruction which puts the boundary scan cells 29 on the scan path, and to pass through the DR-SCAN state 40 twice, once to shift into the boundary scan cells the test data and the control data and to transfer those values into the shadow latches and once more to latch across test data from other boundary scan cells to the input shadow latches, then into the shift register latches and to shift the resulting pattern out of the boundary scan shift register.

The present invention relates to enabling a boundary scan test to be performed so as to include a microprocessor, for example a microcontroller, on the scan path when the microprocessor or microcontroller does not have special circuitry to support boundary scan testing. The approach of the present invention to this problem is to program the microprocessor so that it simulates the behaviour of a JTAG integrated circuit such as those of Figures 1 and 2 in response to test bus and test data signals making use of the resources of the microprocessor as they are without providing any additional circuitry on the microprocessor.

In the present invention the simulation is carried outunder the control of software and the application of the invention to microcontrollers is particularly simple because many microcontrollers have, on chip, an amount of ROM or EPROM in which the software can be stored. Also many microcontrollers have, on chip, an amount of RAM in which the data manipulated by the software can be stored. The resulting device is therefore self-contained.

If the memory in which the test software is stored is of a kind as to permit it, for example if it is RAM or EPROM or EEPROM, the test software could be erased after a JTAG test has been successfully completed so as to release the memory space occupied by the test software for other uses.

By writing software which causes a microprocessor to simulate the hardware and protocol of the JTAG standard, a device, conforming to the standard, can be incorporated into a boundary scan test without any modifications to the device itself. In this way, no costly reengineering of an existing microprocessor is required and microprocessor-based systems can easily be made compatible with existing JTAG test and support hardware.

To simulate the bahaviour of a JTAG circuit the software will have to manipulate the input and output to and from the microprocessor chip via its pins. Microcontrollers usually provide flexible methods of controlling the input and output including having pins which are individually programmable which simplifies the task of writing the software.

One example of a microcontroller, according to the present invention will now be described. Figure 4 is a

block diagram of a TMS370 CX5X microcontroller manufactured by Texas Instruments. A full description of this device can be found in the data sheet published by Texas Instruments. The program used to enable the microcontroller to support boundary scan testing is appended to this specification. The program is written in TMS 370 assembly language. The program is stored in the program memory of the microcontroller, which may be either ROM or EPROM. To simulate the JTAG boundary scan test mode the program expects the microcontroller to be operated in its single chip microcomputer mode which is achieved by applying a LOW signal level input to its MC pin. In this mode the microcontroller defaults to its unexpanded mode with its ports A,B,C,D configured as general purpose input/output ports rather than address, data and control bus connections. The program leaves the microcontroller in this mode.

The program expects the TCK, TMS, TDI signals of the JTAG test bus to be respectively applied to the INT3, SPICLK and SPISOMI pins of the microcontroller and produces the TDO output signal on the SPISIMO pin; of these pins, INT3, is configured to function as a maskable interrupt input and the other pins which are those of the serial peripheral interface are configured as general purpose input/output pins. Of the remaining pins of the microcontroller INT1 and INT2, those of the serial communications interface and those of the timers are configured as general purpose input/output pins and the analogue port is configured as a general purpose digital input port.

The program simulates the functions of the usual JTAG circuitry and in particular it simulates the functions of the test access port controller 33 and its progress through the JTAG state diagram (Figure 3). To do this the program maintains two registers in the RAM memory of the microcontroller, which indicate the next state, one for HIGH values of TMS and one for LOW. Since the JTAG test access port controller and hence the program start off in the TEST-LOGIC-RESET state the program initialises those two registers to indicate TEST-LOGIC-RESET and RUN-TEST/IDLE respectively as the next states. The program then sets up INT3 to generate interrupts at the positive going edges of TCK. On interrupt, an interrupt handling routine checks the value of the TMS signal to see if it is LOW or HIGH and then calls one of a number of routines which perform the functions of the next state, the particular routine chosen being that indicated by the appropriate next state register. In addition to the functions of their state those routines update the next state register appropriately, so that on subsequent interrupts the states are traversed in the manner shown in Figure 3.

Some of the states require action on the negative going edges of TCK, such action being in particular the outputting of the TDO signal ready for it to be received by another integrated circuit on the next positive going edge. The state routines handle this by resetting INT3 to generate interrupts on negative going edges and waiting for an interrupt. When an interrupt occurs the interrupt handling routine outputs the next bit of the TDO signal and restores INT3 to generating interrupts on positive going edges.

The program maintains a register in the RAM of the microcontroller for simulating the instruction register. This register is manipulated by the state routines for the states of the IR-SCAN box 39 of Figure 3 in a similar manner to that applied to the instruction register 35 of the JTAG circuitry. The value or instruction code in this register is then available to the state routines for the states of the DR-SCAN box 40 of Figure 3 so that they can modify their actions accordingly.

JTAG circuitry may in general support all or only some of the instructions specified in the standard. The program appended to this specification supports only the EXTEST and BYPASS instructions. If codes for other instructions are found in the instructions register then the BYPASS instruction is performed.

When the code for the EXTEST instruction is in the instruction register maintained by the program the DR-SCAN 40 state routine manipulates a data register.

The data register occupies seventeen consecutive eight-bit registers of the RAM memory of the microcontroller. A table given in the comment lines at the beginning of the appended program shows how the data register is organised. This data register corresponds to the shift register latches of the boundary scan cells 29 of integrated circuits with special JTAG circuitry provided. The register that corresponds to the shadow latches consists of the latches of the ports of the microcontroller that already exist. Those latches exist in the portion of the memory map of the microcontroller known as the peripheral file. In order that transfers between the data register and the port latches, which transfers correspond to transfers between the shadow latches and their shift register latches respectively, can be made simply, the organisation of the data register reflects that of the port latches in the memory map. Such an organisation has no disadvantages for test pattern generation and analyses systems, such as the ASSET system mentioned above, since they require no particular ordering of input/output latches control data latches and the like, but they do require that the order of these latches and the boundary scan cell or pin to which they belong, are specified to them. Therefore, to test a TMS370 CX5X microcontroller having the appended program using a system such as ASSET, that information as contained in the table will have to be specified to the system.

The transfers made between the data register and the existing port latches are made by the DR-CAPTURE and DR-UPDATE state routines. Respectively, these routines transfer data from the existing port latches to

the data register and in the reverse direction. The shifting of the data register is carried out by the SHIFT-DR routine in which the bit present at the TDI pin 2 is shifted into bit 135 of the data register (see the table at the start of the appended program), data bits already in the register are moved down one bit and bit 0 is set up to be output at the TDO pin 19 at the next negative going edge of the TCK signal by placing it in a register in the RAM called OUTREG in the program. The bit held in OUTREG is set up by the program on the TDO pin on a negative going edge of TCK; in this way the function of the latch 38 of JTAG integrated circuits is simulated.

From the table it can be seen that pins of the microcontroller included on the scan path variously have combined input/output latches, separate input and/or output latches and possibly a control latch. For each of those latches there is a bit of the data register. However, there are some bits of the data register marked by a dash in the "definition" column of the table that are not intended to have corresponding shadow latches. These bits lengthen the shift register and so should be specified to the pattern generation and analysis system as being present but containing no information when read by the analysis system. These bits when the other bits of the data register are transferred into their shadow latches will also, of course, be written into the peripheral file into whatever latch, if any, happens to be at that location. In the present example this has no undesired effects. However in other examples perhaps running other microprocessors this may not be so. A remedy would be to mask out these bits with appropriate values as they are written to the peripheral file or its equivalents.

When the code for the BYPASS instruction is in the instruction register the DR-SCAN 40 state routines simulate the operation of a JTAG integrated circuit having its bypass register on the scan path. In fact all instruction codes other than that for EXTEST will be treated as a BYPASS instruction. The simulation is achieved in the following way:-

In the CAPTURE-DR state routine, a Low or zero is placed in OUTREG ready to be set up on the TDO pin on the next negative going edge of TCK. In the SHIFT-DR state routine the value present at the TDI pin is read and is placed in OUTREG ready to be set up on the TDO pin. In the UPDATE-DE state routine no operation other than to update the next state registers is performed.

The DR-SCAN 40 state routine also makes allowance, for both the BYPASS and EXTEST instructions, for the pipelining of the TMS signal.

It will be appreciated that the method of simulating the behaviour of a JTAG integrated circuit employed by the program described above is not the only possibility. For example, instead of being interrupt driven the program could poll the TCK signal, the data register could be organised differently or a different selection of the pins to which the test bus (TCK,TMS,TDI,TDO) is connected could be made. As another example, a similar program might be written for a microprocessor whose equivalents of ports A,B,C,D of the TMS 370CX5X can only be configured as ports for data, address and control busses. In such a program it would not be so straightforward to produce the desired outputs on those pins, since for example the instruction set of the microprocessor might not allow the pins for the address and data busses to be programmed separately. However, there will be an instruction which writes a data value to a certain address and using this instruction with the desired values could be used to program the ports together. Since these values would possibly only remain on the pins for a few cycles of the microprocessor's clock, allowances would have to be made so that the period during which the data was set up on the pins included the time at which it was latched by other JTAG integrated circuits. Programming the control port at the same time as the address and data busses might not be possible, and the interconnects connected to those pins would have to be tested at different times, with allowance made for that in the test pattern generation and analysis system.

It is not necessary that the software be stored in memory internal to the microprocessor. The JTAG simulation software can be stored in many places, depending on the configuration of the system. If external ROM or PROM or EPROM is used for example, the software could reside there and be a minimal overhead to the total system memory. Conveniently the software could be transferred as a block from the external ROM or PROM or EPROM to the internal RAM of the microprocessor and run from there. Alternatively, a removable test ROM or PROM or EPROM could be used, and replaced by application software after successful testing of the printed circuit board. Many microcontrollers are intended for embedded control in mass-produced end applications. Such devices frequently use on chip masked ROM or EPROM. In the case of EPROM, the device could be erased and reprogrammed by the application software following a successful test.

A particularly advantageous solution can be achieved with microcontrollers such as the TMS370 family, which have on chip EEPROM (non-volatile memory). The JTAG software can be embedded in the device EE-PROM before shipment to the manufacturer of the end equipment, and the application software provided by him on ROM or PROM or EPROM (either on-or off-chip) can read a check byte in the EEPROM at power-up which forces execution of the JTAG software.

Following a successful test, the JTAG software can be erased by the microcontroller itself, perhaps after receiving a special command word in the simulated instruction register. In this way, the JTAG software leaves

no trace of its existence following the test, and the resources it had used are available to the application software in normal use. The special command word could be one of the unused codes of the JTAG standard. The EEPROM of the TMS370 family has the ability to be written to our erased by the microcontroller itself, the 12.6 volts required being generated from the supply rails by an on-chip charge pump.

If the software or the data it manipulates is not stored within the microprocessor but rather off-chip in some other memory then certain of the input and output pins of the microprocessor will be required for transferring instruction words or data words between the microprocessor and that memory. The lines required for the TMS370CX5X microcontroller of Figure 4, would include ports A to D. These lines would not, therefore, be available for direct JTAG testing. However some indication of their functioning would still be provided by a JTAG test since if the program or data was not correctly transferred the test pattern generation and analysis system would not receive a proper response from the microprocessor thus indicating a fault with those lines.

Although the simulation described produces a microprocessor that conforms to the JTAG protocol for boundary scan testing systems, the present invention could be applied to other systems, protocols or standards of boundary scan testing.

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Figure 5 is a diagram of a circuit including a TMS 370C756 microcontroller which has stored in its EPROM memory the program appended to this patent specification. Figure 5 demonstrates the use in boundary scan testing of the circuit and its subsequent use in the application that the circuit was designed for.

The circuit has at its centre the TMS 370C756 microcontroller 41. The analogue port pins AN0 ... AN7 of the microcontroller 41 are connected to a set of eight DIP switches not shown, providing, depending on their positions, either a HIGH or LOW level to the respective pins of the analogue port. Many of the other pins are connected to various of the pins of the A ports of the six octal buffers, 42 to 47 of the type SN74BCT8245. These buffers have special circuitry provided to support JTAG boundary scan testing.

The circuit has terminals 48 to 53 for a JTAG connector cable which connects the circuit to a test pattern generation and analysis system. In particular there are four terminals 50-53 for connection of the test bus signals TMS,TDO,TDI,TCK. The TMS terminal 50 is connected to the TMS input pin of each of the octal buffers 42-27 and to the SPICLK pin of the microcontroller 41 which serves as its TMS pin. The TCK terminal 53 is connected to the TCK input pin of each of the octal buffers 42-47 and to the INT3 pin of the microcontroller 41 which serves as its TCK pin. Also provided in the circuit is a scan path; this starts at the TDI terminal 52 and passes into the microcontroller 41 at its SPISOMI pin, which serves as its TCK pin. The scan path then continues on through each of the octal buffers 42-47 in turn, passing into each at its TDI pin and passing out at its TDO pin, to arrive finally at the TDO terminal 52.

The octal buffers 42-47 and the microcontroller 41 have suitable connections to a power supply, not shown. The microcontroller is suitably connected to a crystal 54 for controlling the frequency of its internal clock. The reset pin of the microcontroller 41 is connected through an RC network to a HIGH signal level, so that the reset pin is held at its active LOW level for a few moments after the power supply is turned on, before rising to a HIGH level and allowing the microcontroller 41 to start operating. The octal buffers 42-47 have their DIR pins connected to a HIGH level, so that the buffers are configured with their A port pins as inputs and their B port pins as outputs. Various of the B port output pins of the octal buffers 42-47 are connected to driver circuits not shown which, depending on the levels of the signal outputs of the buffer, illuminate light emitting diodes, not shown.

The microcontroller 41 having the appended program stored in its EPROM makes the testing of all the interconnections of the circuit with a JTAG test pattern generator and analysis system a straightforward matter. Firstly, the test pattern generator and analysis system is given a description of the circuit in terms of the interconnections between the integrated circuits, those being those between the octal buffers 42-47 and the microcontroller 41, and in terms of the order of, and the latches contained on, the boundary scan cells of the integrated circuits. For the microcontroller the boundary scan cells are simulated by the appended program and the information required is given in the table at the start of the program. The circuit can then be connected to the test pattern generator and analysis system.

In trials of the microcontroller with the appended program it was found that the test bus clock signal TCK could be operated at a rate of up to about 4 kHz.

The full JTAG standard requires, for an integrated circuit to conform to that standard, that the integrated circuit can be clocked at any speed from 0Hz to several MHz. Although clearly the maximum clock rate of 4kHz achieved by the microcontroller in the trial does not conform to the wide ranging speed requirement of the standard, the microcontroller does conform to the JTAG protocol and therefore enables the circuit interconnections to be tested. Since the test as described above does not require redesign of the microcontroller to enable the test to be executed, the microcontroller can retain compatibility with its earlier versions.

The test now proceeds, as described above in relation to Figure 1, with the test pattern generator generating test patterns which are fed to the integrated circuits of the circuit along the scan path. Certain of the bits

of the test pattern after being latched into the integrated circuits are transferred via the circuit interconnections to other latches of the integrated circuits. The resulting pattern of bits is output along the scan path to the analysis system for analysis.

The appended program as it stands does not terminate and expects the testing to continue indefinitely. However it could be modified so that if there were an application program also resident in the EPROM of the microcontroller this could be executed while the appended program was waiting in the TEST-LOGIC-RESET state.

The appended program can be used in the following way. The program is stored in the EPROM of the microcontroller by the manufacturer of the microcontroller before the device is shipped to the manufacturer of a circuit into which it is to be assembled, for example that of Figure 5, who installs the microcontroller in the circuit and tests the circuit wiring using boundary scan testing as described above. Once the test has been successfully completed, the program is of no further use (except perhaps if the circuit is returned for servicing by its end user), and consequently the storage space in the EPROM is wasted. The manufacturer of the assembled circuit can, if he wishes, erase the program in the EPROM and use the space to store at least part of an application program required to operate the circuit. In that way, all of the EPROM storage space can be used for application programs after the test program has been erased. In the case of the circuit of Figure 5 such an application program might illuminate the light emitting diodes in a sequence which depends on the setting of the DIP switches.

Such rewriting of the EPROM means that a JTAG testable microcontroller has been provided not only without special circuitry being added to the design of the microcontroller but also without permanently using any of the resources of the microcontroller except for the four pins used for connection to the test bus. The latter is not a serious disadvantage because very few circuits including a microcontroller require the use of all of their pins and the program can easily be rewritten so that connection of the test bus is made to otherwise unused pins. If necessary it might be possible after testing of the circuit to reconnect the pins connected to the test bus to other interconnections by moving links or with other means.

APPENDIX

5	; THE DATA REGISTER DEFINITIONS FOLLOW :-					
	; BIT NUMBER	PIN No.	DEFINITION	REGISTER	BIT No.	PPILE
10	; 0 ; 1 ; 2 ; 3 ; 4	17 18 19 20 21	AO DATA A1 DATA A2 DATA A3 DATA A4 DATA	R100	0 1 2 3 4	P022
15	; 5 ; 6 ; 7 ; 8 ; 9 ; 10	22 23 24 	A5 DATA A6 DATA A7 DATA A0 DDR A1 DDR A2 DDR	R101	5 6 7 0 1 2	P023
20	; 11 ; 12 ; 13 ; 14 ; 15 ; 16 ; 17	 65 66	A3 DDR A4 DDR A5 DDR A6 DDR A7 DDR B0 DATA B1 DATA	R102	3 4 5 6 7	P026
25	; 18 ; 19 ; 20 ; 21 ; 22 ; 23	67 68 1 2 3	B1 DATA B2 DATA B3 DATA B4 DATA B5 DATA B6 DATA B7 DATA		1 2 3 4 5 6 7	
30	; 24 ; 25 ; 26 ; 27 ; 28 ; 29		BO DDR B1 DDR B2 DDR B3 DDR B4 DDR B5 DDR	R103	0 1 2 3 4 5	P027
35	; 30 ; 31 ; 32 ; 33 ; 34 ; 35	 5 7 8 10	B6 DDR B7 DDR C0 DATA C1 DATA C2 DATA C3 DATA	R104	6 7 0 1 2 3	P02A
40	; 36 ; 37 ; 38 ; 39 ; 40 ; 41 ; 42 ; 43	11 12 13 14 	C4 DATA C5 DATA C6 DATA C7 DATA C0 DDR C1 DDR C2 DDR C3 DDR	R105	4 5 6 7 0 1 2	P02B
45	; 44 ; 45 ; 46 ; 47 ; 48 ; 49	 64 60	C4 DDR C5 DDR C6 DDR C7 DDR D0 DATA D1 DATA	R106	3 4 5 6 7 0	P02E
50	; 50 ; 51 ; 52 ; 53 ; 54 ; 55	59 58 57 56 55 54	D2 DATA D3 DATA D4 DATA D5 DATA D6 DATA D7 DATA		2 3 4 5 6 7	
55	; 56 ; 57 ; 58		DO DDR D1 DDR D2 DDR	R107	0 1 2	P02F

	;	59		D3 DDR	3	
	;	60		. D4 DDR	4	
_	;	61		D5 DDR	5	
5	;	62		D6 DDR	6	
	;	63		D7 DDR	7	
	;	64		TIEVT DDR R108	0	P04D
	;	65			1	
	;	66	44	TIEVT DATA OUT	2	
	;	67	44	T1EVT DATA IN	3	
10	;	68			4	
	;	69			5	
	;	70 .			6	
	;	71			7	
	į	72		TICR DDR R109	0	P04E
	,	73			1	
15	į	74	46	TICR DATA OUT	2	
	,	75 76	46	T1CR DATA IN	3	
	į	76		T1PWM DDR	4	
	,	77			5	
	,	78 79	45	T1PWM DATA OUT	6	
			45	T1PWM DATA IN	7	
20		80		T2EVT DDR R110	0	P06D
20		81	25		1	
	<i>i</i>	82 83	25 25	T2EVT DATA OUT	2	
	:	84	25	T2EVT DATA IN	3	
	:	85			4	
	'	86			5	
05	′,	87			6 7	
25	:	88	- ·	T2CR DDR R111	0	PO6E
	<u> </u>	89		R111	1	PUGE
	;	90	27	T2CR DATA OUT	2	
	;	91	27	T2CR DATA IN	3	
	;	92		T2PWM DDR	4	
	;	93			5	
30	;	94	26	T2PWM DATA OUT	6	
	;	95	26	T2PWM DATA IN	7	
	7	96		SCICLK DDR R112	0	P05D
	;	97			1	
	;	98	28	SCICLK DATA OUT	2	
	;	99	28	SCICLK DATA IN	3	
35	;	100			4	
	;	101			5	
	;	102			6	
	;	103	~		7	
	7	104		SCIRXD DDR R113	0	P05E
	7	105			1	
40	;	106	29	SCIRXD DATA OUT	2	
	;	107	29	SCIRXD DATA IN	3	
	;	108		SCITXD DDR	4	
	;	109			5	
	į	110	30	SCITXD DATA OUT	6	
	į	111	30	SCITXD DATA IN	7	_
45	į	112	36	AN 0 R114	0	P07D
	7	113 114	37	AN 1	1	
	į		38	AN 2	2	
	i .	115	39	AN 3	3	
	į	116	40	AN 4	4	
	į	117	41	AN 5	5 6	
50	į	118	42	AN 6		
	!	119	43	AN 7	7	50. 5
	į.	120 121		R115	0	P017
	į.	121			1	
	į	122			2	

5	;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;	127 128 129 130 131 132	52 51 51	 INT2 INT2	DATA IN DATA OUT DDR DATA IN	R116	3 4 5 6 7 0 1 2 3 4 5 6 7		P018
15	; ; ; ;	TDI = SPISOMI TDO = SPISIMO							
20	; ; ; ; ;	TMS = SPICLK TCK = INT3 INTERNAL REGI	PIN 4 PIN 5 STER ALLO	0	FOLLOWS	s :-			
25	; ; ; ;	STACK OUTREG BYPASS REGIS	R50 TER R51		DATA	ısed	R OUTPUT		
30	; ; ; ;	STATE_L REG STATE_H REG STATE_H REG	R53 R54	(35H)	HOLDS	S LSB OF	NEXT ST	ATE IF	TMS=0 TMS=1
35	;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;;	INSTRUCTION TMS_DELAY DATA REGISTE	REG R56	(38H)		FLAG F	NEXT ST		
40	; ; ; ;				·				
45	;;;;				·				

```
.text
                  .GLOBAL DR CAPTURE
                  .GLOBAL DR SHIFT
5
                  .GLOBAL DR EXIT1
                  .GLOBREG STATE_H
.GLOBREG STATE_L
.GLOBREG INSTRUCT_REG
                  GLOBREG OUTREG
GLOBREG TMS_DELAY
10
       DR_CAPTURE
                            MOV
                                        #01H, TMS DELAY
                                       #00H,INSTRUCT_REG ; CHECK INSTRUCTION REGISTER BYPASS_C ; IF NOT 00, ASSUME BYPASS
                            CMP
                            JNZ
                                       BYPASS_C
         INSTRUCTION=0, SO MODE MUST BE XTEST LOAD ALL I/O INTO RAM BASED SHIFT REGISTER
                            MOV
                                       P022,R100
                                                                 PORT A I/O
                            MOV
                                       P023,R101
                                                                 PORT A DDR
                            MOV
                                                                 PORT B I/O
PORT B DDR
                                       P026,R102
                            MOV
                                       P027,R103
20
                                                                 PORT C I/O
PORT C DDR
                            MOV
                                       P02A, R104
                            MOV
                                       P02B,R105
                                                                 PORT D I/O
PORT D DDR
                                       P02B,R106
P02F,R107
                            MOV
                            MOV
                                       P04D,R108
P04B,R109
                                                                 TIMER 1 I/O
TIMER 1 I/O
                            MOV
                            MOV
25
                            MOV
                                       P06D,R110
                                                                 TIMER 2 I/O
                            MOV
                                       P06B,R111
                                                                 TIMER 2 1/0
                                                                SCI I/O
SCI I/O
A-D I/P
INT1 I/O
INT2 I/O
                            MOV
                                       P05D,R112
                            MOV
                                       P05E,R113
                            MOV
                                       P07D,R114
                            MOV
                                       P017,R115
                            MOV
                                       P018,R116
30
       CAPTURE_NEXT
                            MOVW
                                        #DR_SHIFT, STATE_L
                                                                       ; NEXT STATE IS DR SHIFT
                            MOVW
                                        #DR_EXIT1,STATE_H
                                                                        ; NEXT STATE IS DR EXIT1
                            RTS
       BYPASS_C
35
                            MOV
                                        #010H,OUTREG
                                                                        ; LOAD '0' INTO OUTPUT REGIST
                            JMP
                                       CAPTURE NEXT
       ;
                             .END
40
```

14

45

50

```
.text
                      GLOBAL DR EXIT1
GLOBAL DR PAUSE
GLOBAL DR UPDATE
GLOBAL DR SHIFT1
GLOBAL BYPASS S1
5
                      GLOBREG STATE H
GLOBREG STATE L
GLOBREG TMS_DELAY
GLOBREG INSTRUCT_REG
10
         SPIPC2
                     .EQU
                                   P03E
         DR EXIT1
                                   BTJO
                                                #01,TMS_DELAY,NO_DELAY1
#01,TMS_DELAY
                                   MOV
15
         DELAYI
                                                #00H,INSTRUCT_REG ; CHECK INSTRUCTION REGISTER BYPASS_DELAY ; IF NOT 00H, ASSUME BYPASS
                                   CMP
                                   JNZ
         SHIFT_DELAY
                                   CALL
                                                DR_SHIFT1
                                   JMP
                                                NO DELAY1
20
         BYPASS DELAY
                                   CALL
                                                BYPASS_S1
         NO_DELAY1
                                   MOVW
                                                                                      ; NEXT STATE IS DR_PAUSE ; NEXT STATE IS DR_UPDATE
                                                #DR_PAUSE, STATE L
                                   MOVW
                                                #DR_UPDATE,STATE_H
                                   RTS
25
                                   . END
                        .text
                       .GLOBAL DR_EXIT2
.GLOBAL DR_SHIFT
.GLOBAL DR_UPDATE
30
                        .GLOBREG STATE_H
.GLOBREG STATE_L
                                                 #DR_SHIFT,STATE_L
#DR_UPDATE,STATE_H
           DR EXIT2
                                     MOVW
                                                                                       ; NEXT STATE IS DR_SHIFT ; NEXT STATE IS DR_UPDATE
35
                                     MOVW
                                     RTS
                                     .END
40
                     .text
                     .GLOBAL DR EXIT2
                     .GLOBAL DR PAUSE
.GLOBREG STATE H
.GLOBREG STATE_L
45
        DR_PAUSE
                                  MOVW
                                               #DR_PAUSE, STATE L
                                                                                     ; NEXT STATE IS PAUSE
                                               #DR_EXIT2,STATE_H
                                  MOVW
                                                                                     ; NEXT STATE IS DR_UPDATE
                                  RTS
        ;
                                  .END
50
```

```
.text
.GLOBAL IR_SCAN
.GLOBAL DR_SCAN
.GLOBAL DR_CAPTURE
.GLOBREG STATE_L
.GLOBREG STATE_H
5
            ;
SPIPC2 .EQU
                                           P03E
10
            DR_SCAN
                                           MOVW
                                                           #DR_CAPTURE,STATE_L
#IR_SCAN,STATE_H
                                                                                                        ; NEXT STATE IS DR_SHIFT ; NEXT STATE IS IR_SCAN
                                           MOVW
                                           RTS
            ;
                                           . END
15
20
25
30
35
40
45
50
55
```

```
.text
                 .GLOBAL DR EXIT1
                .GLOBAL DR SHIFT
.GLOBAL DR SHIFT1
5
                .GLOBAL BYPASS S1
.GLOBREG STATE L
.GLOBREG STATE H
.GLOBREG OUTREG
.GLOBREG OUTREG
.GLOBREG OUTREG
10
                 .GLOBREG TMS_DELAY
      SPIPC2
                          .EQU
                                    P03E
      INT3CTL
                           .EQU
                                    P019
      DR SHIFT
                          CMP
                                    #00H, INSTRUCT_REG ; CHECK INSTRUCTION REGISTER
15
                          JNZ
                                    BYPASS_S
                                                            ; IF NOT OOH, ASSUME BYPASS
      ï
                          втло
                                    #01H, TMS_DELAY, OUTPUT
                                                                 ; IS THIS THE FIRST TIME
                                                                 ; INTO DR SHIFT ? IF SO,
; DON'T SHIFT !
                          CALL
                                    DR_SHIFT1
                          JMP
                                    TUTTUO
20
      ; SHIFT REGISTER ROUTINE, BY ROTATING TEROUGH CARRY THE LEAST SIGNIFICANT; BIT OF EACH REGISTER CAN BE INPUT TO THE NEXT REGISTER IN THE CHAIN
      ; AUTOMATICALLY.
      DR SHIFT1
                          BTJO
                                    #08H,SPIPC2,IN_ONE
                                                                 ; COPY TDI (SPISOMI) TO CARRY
25
      IN_ZERO
                          CLRC
                          JMP
                                    ROTATE
      IN_ONE
                          SETC
      ROTATE
                          RRC
                                    R116
                                                                 ; SHIFT STATE OF SPISOMI INTO
                          RRC
                                    R115
                                                                 ; R116 AND SHIFT ALL REGISTER
                          RRC
                                    R114
                                                                  ; TOWARDS LSB.
30
                          RRC
                                    R113
                          RRC
                                    R112
                          RRC
                                    R111
                          RRC
                                    R110
                          RRC
                                    R109
                          RRC
                                    R108
                          RRC
                                    R107
35
                          RRC
                                    R106
                          RRC
                                    R105
                          RRC
                                    R104
                          RRC
                                    R103
                          RRC
                                    R102
                          RRC
                                    R101
                                                                 ; LAST SHIFT FEEDS LSB
                          RRC
40
                                    R100
                                                                 ; INTO CARRY
                          RTS
      OUTPUT
                                    #01E,R100,OUT_ONE
                          BTJO
                                                                 ; PRE-LOAD OUTPUT REG WITH
      OUT ZERO
                          MOV
                                    #010H,OUTREG
                                                                 ; LSB AND TOO ENABLE BIT
                                    WAIT_NEG1
#050H,OUTREG
                          JMP
                                                                 ; READY FOR -VE TCK EDGE
      OUT ONE
                          MOV
45
      WAIT NEG1
                          MOV
                                    #00H, TMS_DELAY
                          MOV
                                                                 ; ENABLE TCK (INT3) FOR
                                    #01H, INT3CTL
                          EINTH
                                                                 ; -VE EDGE DETECTION
                          IDLE
      ;
                          MOVW
                                    #DR_SHIFT, STATE_L
50
                                                                 ; NEXT STATE IS DR SHIFT
                          MOVW
                                    #DR_EXIT1,STATE_H
                                                                 ; NEXT STATE IS DR EXIT1
                          RTS
```

```
$01H,TMS_DELAY,WAIT_NEG1 ; IS THIS THE FIRST TIME
BYPASS_S1 ; INTO BYPASS ? IF SO,
WAIT_NEG1 ; DON'T SHIFT !
      BYPASS_S
                           BTJO
                           CALL
5
                           JMP
      BYPASS S1
                           BTJO
                                      #08H,SPIPC2,IN_ONE2
                                                                    ; READ TDI (SPISOMI)
      IN ZERO2
                           MOV
                                      #010H, OUTREG
10
                                                                    ; LOAD '0' INTO OUTPUT REGIST
                           RTS
      IN_ONE2
                           MOV
                                      #050H,OUTREG
                                                                    ; LOAD '1' INTO OUTPUT REGIST
                           RTS
                           .END
15
                  .text
                   .GLOBAL DR_SCAN
                  .GLOBAL RUN TEST
                  .GLOBAL DR UPDATE
.GLOBREG STATE H
20
                  .GLOBREG STATE L
.GLOBREG INSTRUCT REG
       SPIPC2 .EQU
                             P03E
25
       DR_UPDATE
                             MOV
                                        #00,SPIPC2
                                                         ; TRI-STATE TDO
                             CMP
                                        #00H, INSTRUCT_REG ; CHECK INSTRUCTION REGISTER
                                        BYPASS
                             Jnz
                                                                  ; IF NOT OOH, ASSUME BYPASS
                             MOV
30
                                        R100,P022
                                                                  PORT A I/O
                                        R101,P023
R102,P026
                             MOV
                                                                 PORT A DOR
                                                                 PORT B I/O
PORT B DDR
                             MOV
                             MOV
                                        R103,P027
                             MOV
                                                                  PORT C I/O
                                        R104, P02A
                                        R105,P02B
R106,P02E
R107,P02F
R108,P04D
                                                                 PORT C DDR
PORT D I/O
PORT D DDR
TIMER 1 I/O
TIMER 1 I/O
                             MOV
                             MOV
35
                             MOV
                             MOV
                                        R109, P04E
                             MOV
                             MOV
                                        R110, P06D
                                                                  TIMER 2 I/O
                             MOV
                                        R111, P06E
                                                                  TIMER 2 1/0
                                        R112,P05D
R113,P05E
                             MOV
                                                                 SCI I/O
SCI I/O
40
                             MOV
                             MOV
                                        R114,P07D
R115,P017
                                                                 A-D I/P
INT1 I/O
INT2 I/O
                             MOV
                             MOV
                                        R116, P018
       .
BYPASS
                             MOVW
                                        #RUN_TEST, STATE L
                                                                        ; NEXT STATE IS RUN TEST
45
                             MOVW
                                        #DR SCAN, STATE H
                                                                        ; NEXT STATE IS DR SCAN
                             RTS
       ;
                             .END
50
```

```
.text
                   .GLOBAL IR_CAPTURE .GLOBAL IR_SHIFT
5
                   .GLOBAL IR EXIT1
                   GLOBREG STATE H
GLOBREG STATE L
GLOBREG INSTRUCT REG
GLOBREG TMS_DELAY
        IR CAPTURE
                             MOV
                                         #01H,TMS DELAY
10
                                                                        ; LOAD INSTRUCTION REG ; WITH 0000 0001
                              MOV
                                         #01H, INSTRUCT_REG
        ;
                             MOVW
                                         #IR_SHIFT, STATE L
                                                                        ; NEXT STATE IS IR SHIFT
                                                                        ; NEXT STATE IS IR EXIT1
                              MOVW
                                         #IR_EXIT1,STATE H
15
                              RTS
                              .END
                   .text
                   .GLOBAL IR_EXIT1
20
                   .GLOBAL IR_PAUSE
                  .GLOBAL IR UPDATE .GLOBAL IR SHIFT1
                  .GLOBREG STATE H .GLOBREG STATE L
                   .GLOBREG TMS_DELAY
25
       SPIPC2
                  .EQU
                             P03E
       ;
       IR EXIT1
                             BTJO
                                        #01, TMS_DELAY, NO DELAY
       EXIT1_DELAY
                             MOV
                                        #01,TMS_DELAY
30
                             CALL
                                        IR_SHIFT1
       NO_DELAY
                             MOVW
                                                                        ; NEXT STATE IS IR_PAUSE ; NEXT STATE IS IR_UPDATE
                                        #IR_PAUSE, STATE L
                             MOVW
                                        #IR_UPDATE, STATE H
                             RTS
                             .END
35
                    .text
                    .GLOBAL IR EXIT2
                    GLOBAL IR SHIFT
GLOBAL IR UPDATE
GLOBREG STATE H
GLOBREG STATE L
40
         İR_EXIT2
                               MOVW
                                          #IR SHIFT, STATE L
                                                                        ; NEXT STATE IS IR SHIFT
                               MOVW
                                          #IR_UPDATE,STATE_H
                                                                         ; NEXT STATE IS IR_UPDATE
                               RTS
45
                               .END
                    .text
                    .GLOBAL IR EXIT2
50
                    .GLOBAL IR PAUSE
                   .GLOBREG STATE_H
.GLOBREG STATE_L
         IR_PAUSE
                                                                         ; NEXT STATE IS IR_PAUSE ; NEXT STATE IS IR_UPDATE
                              MOVW
                                         #IR_PAUSE, STATE L
                              MOVW
                                         #IR_EXIT2,STATE_H
                              RTS
55
         ;
                               - END
```

```
.text
                   .GLOBAL IR_SCAN
                   GLOBAL TL RESET
GLOBAL IR CAPTURE
GLOBREG STATE L
GLOBREG STATE B
GLOBREG TMS DELAS
5
        TMS DELAY
                             .EQU
        SPIPC2
                  . EQU
                             P03E
10
                             MOVW
                                        #IR_CAPTURE,STATE_L
                                                                       ; NEXT STATE IS IR_SHIFT
        IR SCAN
                                                                        ; NEXT STATE IS TL_RESET
                             MOVW
                                        #TL_RESET, STATE_H
                             RTS
15
                              .END
                  .text
                .GLOBAL IR EXIT1
.GLOBAL IR SHIFT
.GLOBAL IR SHIFT1
.GLOBREG STATE L
20
                 .GLOBREG STATE H
                 .GLOBREG INSTRUCT REG
.GLOBREG TMS_DELAY
25
       SPIPC2
                          .EQU
                                      P03E
       INT3CTL
                          .EQU
                                      P019
30
       IR_SHIFT
                           втјо
                                      $01H,TMS_DELAY,OUTPUT1 ; IS THIS THE FIRST TIME
                           CALL
                                      IR SHIFTI
                                                                    ; INTO IR SHIFT ? IF SO,
                            JMP
                                      OUTPUT1
                                                                    ; DON'T SHIFT !
       IR SHIFT1
                           BTJO
                                      #08H,SPIPC2,IN_ONE1
                                                                    ; COPY TDI (SPISOMI) TO CARRY
       IN_ZERO1
                           CLRC
35
                                      ROTATE_IR
                           JMP
       IN ONE1
                           SETC
      ROTATE_IR
                           RRC
                                      INSTRUCT REG
                                                                    ; SHIFT STATE OF TDI (SPISOMI ; INTO INSTRUCTION REGISTER R
                           RTS
                                                                       TOWARDS LSB.
       OUTPUT1
                                      #01H, INSTRUCT_REG, OUT_ONE1 ; STATE OF IR LSB ?
                           BTJO
40
       OUT_ZERO1
                                     #010H,OUTREG
WAIT NEG
#050H,OUTREG
                           VOM
                                                                         ; COPY LSB TO O/P REG
                           JMP
      OUT_ONE1
                           MOV
       WAIT NEG
                           MOV
                                      #00H, TMS_DELAY
                                                                    ; CLEAR TMS DELAY
45
                           MOV
                                      #01H, INT3CTL
                                                                    ; ENABLE TCK (INT3) FOR
                           BINTH
                                                                    ; -VE EDGE DETECTION
                           IDLE
                                                                    ; NEXT STATE IS IR_SHIFT ; NEXT STATE IS IR_EXIT1
                           MOVW
                                      #IR SHIFT, STATE L
                           MOVW
                                      #IR_EXIT1,STATE_H
                           RTS
50
                           .END
```

```
.text
.GLOBAL DR_SCAN
.GLOBAL RUN_TEST
.GLOBAL IR_UPDATE
                        .GLOBREG STATE_H
.GLOBREG STATE_L
5
          SPIPC2 .EQU
                                      P03E
          ;
IR_UPDATE
                                      MOV
                                                     #00,SPIPC2
                                                                                               ; TRI-STATE TDO
10
                                                     #RUN_TEST,STATE_L
#DR_SCAN,STATE_H
                                                                                               ; NEXT STATE IS RUN_TEST ; NEXT STATE IS IR_SCAN
                                      MOVW
                                      MOVW
                                      RTS
          ï
                                       .END
15
                         .text
.GLOBAL RUN_TEST
.GLOBAL DR_SCAN
.GLOBREG STATE_E
.GLOBREG STATE_L
20
                                                      #RUN_TEST,STATE_L
#DR_SCAN,STATE_H
                                                                                             ; NEXT STATE IS RUN_TEST ; NEXT STATE IS DR_SCAN
           RUN_TEST
                                        MOVW
                                        MOVW
                                        RTS
           ;
                                        .END
25
30
35
40
45
50
55
```

```
.text
               .GLOBAL START
               GLOBAL TCK
GLOBAL TL RESET
GLOBAL RUN TEST
5
               .GLOBREG STATE_H
               .GLOBREG STATE L
               .GLOBREG OUTREG
.GLOBREG INSTRUCT REG
.GLOBREG BYPASS_REG
10
      INT3CTL
                        .EQU
                                 P019
      ADENA
                        .EQU
                                 P07E
      STATE L
                        .EQU
                                 R53
      STATE_H
                        .EQU
                                 R55
      OUTREG
                        .EQU
                                 R50
      BYPASS REG
                        - EQU
                                 R51
15
      INSTRUCT_REG
                        .EQU
                                 R56
               . SECT
                        ROMCODE
                                                    ; THIS TEST RESIDES IN ROM
               SOME KIND OF JTAG ENTRY TEST IS REQUIRED HERE
      START
               NOP
               NOP
                                                   ; ALL I/O ASSUMED TRI-STATE
20
               NOP
               NOP
               BR
                        JTAG
                                                   ; BRANCH TO JTAG CODE IN EEPROM
               .TEXT
                                                   ; EEPROM STARTING ADDRESS ???
      JTAG
                        #OFFH, ADENA
               VOM
                                                   ; ENABLE A-D INPUTS
               MOVW
                        #TL_RESET,STATE_H
                                                   ; INITILISE STATE TO TL_RESET
25
                        #RUN_TEST,STATE_L
#014H,B
               MOVW
               VOM
               LDSP
                                                    ; INITIALISE STACK POINTER AT R20
               VOM
                        #00,P017
                                                    ; DISABLE ALL UNUSED INTS
               VOM
                        #00,P018
               VOM
                        #00,P04B
30
               MOV
                        #00,P06B
               MOV
                        #00,P055
               MOV
                        #00,P054
               MOV
                        #00,P031
               MOV
                        #00,P071
                        #05H, INT3CTL
               VOM
                                                    ; ENABLE TCK (INT3) +VE EDGE
35
               EINTH
      WAIT
               IDLE
                        WAIT
               BR
                                                    ; WAIT FOR NEXT TCK
      ;
                . SECT
                       VECTORS
                .WORD
                         TCK
                                                    ; INT3 VECTOR FOR TCK 7FF8,7FF9
40
                .WORD
                         START
                                                    ; INT2 VECTOR UNUSED
                                                    ; INT1 VECTOR UNUSED
                .WORD
                         START
                .WORD
                         START
                                                    ; RESET VECTOR TO ROM 7FFE,7FFF
                .END
```

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50

```
.text
                .GLOBAL TCK
                .GLOBREG OUTREG
.GLOBREG STATE_L
5
                .GLOBREG STATE H
      SPIPC1
               . EQU
                         P03D
      SPIPC2 .EQU
INT3CTL .EQU
                         P03E
                         P019
      ŤCK
10
                         MOV
                                   #05H, INT3CTL
                                                               ; CLEAR INT3
                         BTJZ
                                   #040H, INT3CTL, TCK_NEG
                                                               ; +VE OR -VE EDGE ON TCK (INT
      TCK_POS
                         BTJO
                                   #08H,SPIPC1,TMS HI
                                                               ; CHECK STATE OF TMS (SPICLK)
      TMS_LO
                         CALL
                                   ESTATE L
                         RTI
15
      TMS_HI
                         CALL
                                   estate H
                                                               ; CALL NEXT STATE ROUTINE
                         RTI
      ;
TCK_NEG
                         MOV
                                   OUTREG, SPIPC2
                                                               ; OUTPUT BIT TO TDO (SPISIMO)
                         MOV
                                   #05, INT3CTL
                                                               ; RE-ARM TCK FOR +VE EDGE
20
                         RTI
                         .END
25
                 .text
                 .GLOBAL TL_RESET .GLOBAL RUN_TEST
                 .GLOBREG STATE L
.GLOBREG STATE H
.GLOBREG INSTRUCT_REG
30
       ;
SPIPC2 .EQU
                           P03E
       TL RESET
                           VOM
                                     #00,SPIPC2
                                                                   ; TRI-STATE TDO
                           VOM
                                     #OFFH, INSTRUCT_REG
                                                                   ; DEFAULT BY-PASS MODE
35
                                     #RUN_TEST,STATE_L
#TL_RESET,STATE_H
                           MOVW
                                                                   ; NEXT STATE IS RUN_TEST
                           MOVW
                                                                   ; NEXT STATE IS TL_RESET
                           RTS
                            .END
40
45
50
```

```
SETUP.OBJ
                  STATE.OBJ
                  TL_RESET.OBJ
5
                  RUNTEST.OBJ
                 DR_CAPT.OBJ
DR_EXIT1.OBJ
DR_EXIT2.OBJ
DR_PAUSE.OBJ
DR_SCAN.OBJ
                 DR_SHIFT.OBJ
DR_UPDAT.OBJ
10
                 IR_CAPT.OBJ
                 IR EXIT1.OBJ
                 IR_EXIT2.OBJ
                 IR_SCAN.OBJ
15
                 IR_SHIFT.OBJ
                  IR_UPDAT.OBJ
                 -o JTAG.OUT
-m JTAG.MAP
20
                 MEMORY
                     RFILE: origin = 02h length = 0FEh
ROM: origin = 7000h length = 1000h
EEPROM: origin = 01F00h length = 0100h
                  SECTIONS
25
                        ROMCODE 07000h : { } > ROM .text 07700h : { } > ROM VECTORS 07FF8h : {} > ROM
                                                                                       /* WILL BE EEPROM !! */
                  }
30
```

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```
************
            TMS370 COFF Linker
                                            Version 3.40
            *********
           Mon Mar 26 21:21:10 1990
5
            OUTPUT FILE NAME:
                                 <JTAG.OUT>
            ENTRY POINT SYMBOL: 0
           MEMORY CONFIGURATION
10
                                  origin
                                              length
                       name
                                                           attributes
                     RETTE
                                  00000002
                                             0000000fe
                                                              RWIX
                     EEPROM
                                  00001f00
                                             000000100
                                                              RWIX
                     ROM
                                  00007000
                                             000001000
                                                              RWIX
15
            SECTION ALLOCATION MAP
            output
                                                        attributes/
            section
                       page
                               origin
                                            length
                                                          input sections
20
                                          00000007
            ROMCODE
                             00007000
                               00007000
                                            00000007
                                                          SETUP.OBJ (ROMCODE)
            .text
                             00007700
                                          0000020Ъ
                        0
                               00007700
                                             0000002f
                                                           SETUP.OBJ (.text)
                                0000772f
                                             00000018
                                                           STATE.OBJ (.text)
                                                           TL_RESET.OBJ (.text)
25
                               00007747
                                             0000000f
                               00007756
                                             00000009
                                                           RUNTEST.OBJ (.text)
                                0000775f
                                             00000049
                                                           DR_CAPT.OBJ (.text)
                                                          DR_EXIT1.OBJ (.text)
DR_EXIT2.OBJ (.text)
DR_PAUSE.OBJ (.text)
                                000077a8
                                             0000001d
                               000077c5
                                             00000009
                                000077ce
                                             00000009
                                000077d7
                                             00000009
                                                           DR_SCAN.OBJ (.text)
30
                                                          DR_SHIFT.OBJ (.text)
DR_UPDAT.OBJ (.text)
IR_CAPT.OBJ (.text)
                                000077e0
                                             0000006c
                                0000784c
                                             00000044
                                00007890
                                             0000000f
                                                          IR_EXIT1.OBJ (.text)
IR_EXIT2.OBJ (.text)
IR_PAUSE.OBJ (.text)
                                0000789f
                                             00000013
                                000078b2
                                             00000009
                                000078bb
                                             00000009
35
                                                           IR_SCAN.OBJ (.text)
IR_SHIFT.OBJ (.text)
                                000078c4
                                             00000009
                                000078cd
                                             00000032
                                                           IR_UPDAT.OBJ (.text)
                                000078ff
                                             000000c
            VECTORS
                             00007ff8
                                          00000008
                                00007ff8
                                             80000008
                                                           SETUP.OBJ (VECTORS)
40
            .data
                        0
                             00000000
                                          00000000
                                                         UNINITIALIZED
            .bss
                        0
                             00000000
                                          00000000
                                                         UNINITIALIZED
            GLOBAL SYMBOLS
45
            address name
                                                          address name
            00000000 .bss
                                                          00000000 edata
            00000000 .data
                                                          00000000 .data
            00007700 .text
                                                          00000000 end
50
                                                          00000000 .bss
00000032 OUTREG
            00000033 BYPASS REG
            00007840 BYPASS S1
            0000775f DR_CAPTURE
                                                          00000033 BYPASS_REG
```

	000077a8 DR_EXIT1	00000035	STATE L
	000077c5 DR_EXIT2	00000037	STATE H
5	000077ce DR_PAUSE	00000038	INSTRUCT REG
9	000077d7 DR_SCAN	00000039	TMS_DELAY
	000077ee DR_SHIFT1	00007000	
	000077e0 DR_SHIFT	00007700	.text
	0000784c DR_UPDATE	0000772f	TCK
	00000038 INSTRUCT_REG	00007747	TL RESET
	00007890 IR_CAPTURE	00007756	RUN TEST
10	0000789f IR_EXIT1	0000775£	DR CAPTURE
	000078b2 IR_EXIT2		DR EXIT1
	000078bb IR_PAUSE	000077c5	DR EXIT2
	000078c4 IR_SCAN	000077ce	DR PAUSE
	000078d6 IR_SHIFT1	000077d7	DR SCAN
	000078cd IR_SHIFT		DR SHIFT
45	000078ff IR_UPDATE	000077ee	DR SHIFT1
15	00000032 OUTREG	00007840	BYPASS S1
	00007756 RUN TEST		DR UPDATE
	00007000 START		IR CAPTURE
	00000037 STATE H		IR EXIT1
	00000035 STATE_L		IR EXIT2
	0000772f TCK -		IR PAUSE
20	00007747 TL RESET	000078c4	
	00000039 TMS DELAY		IR SHIFT
	00000000 edata		IR SHIFT1
	00000000 end	000078ff	IR_UPDATE
	0000790b etext	0000790b	etext
25	[33 symbols]		
20	· · · · · · · · · · · · · · · · · · ·		

Claims

Clain

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1. A method of testing interconnections of a circuit having a plurality of integrated circuits,

at least some of the integrated circuits including

storage elements respectively associated with some of the terminals of those integrated circuits and means for joining the storage elements into at least one shift register chain,

the method including

entering an initial test pattern of bits serially into the storage elements along the at least one shift register chain,

transferring certain of the bits of the initial test pattern from the storage elements into which they were entered, via the terminals and interconnections, to others of the storage elements,

retrieving the resulting pattern of bits serially from the storage elements along the at least one shift register chain, and

comparing the initial test pattern and resulting pattern to derive information about the interconnections,

characterised in that

at least one of the plurality of integrated circuits is a microprocessor, there being stored in the circuit a test program which causes the microprocessor to perform a number of operations including

entering serially into the microprocessor part of the initial test pattern of bits and storing it in a memory,

reading certain of the bits stored in the memory and producing corresponding output signals on terminals of the microprocessor connected to particular interconnections,

reading bits via particular interconnections at terminals of the microprocessor and storing the received bits in the memory, and

producing as an output from the microprocessor in serial form the received bits stored in the memory, so as to enable interconnections connected to terminals of the microprocessor to be tested.

- A method according to claim 1 wherein the microprocessor has internal memory including a read-write memory, the bits of the part of the initial test pattern being stored in that read-write memory.
- 3. A method according to claim 1 or claim 2, wherein the microprocessor has internal memory including a

non-volatile memory, the test program being stored in the non-volatile memory.

- 4. A method according to claim 1 or claim 2, wherein the test program is stored in non-volatile memory external to the microprocessor, the program being transferred from that memory to a read-write memory internal to the microprocessor, the program being executed from that internal memory.
 - 5. A method according to claim 3 or claim 4, wherein after a successful test of the interconnections of the circuit, the test program is deleted from that non-volatile memory in which it is stored, thereby releasing that memory for re-use.
 - 6. A method according to claim 3 or claim 4 or claim 5, wherein the non-volatile memory is EEPROM.
 - 7. A method according to any one of the preceding claims in which control signals are applied to the integrated circuits to regulate the operations on the bits of the initial test pattern and the bits derived therefrom, wherein the test program in the microprocessor either polls inputs to which the control signals are applied or is interrupted by the control signals so as to cause the test program to execute operations corresponding to those performed by the other integrated circuits in response to the control signals.
- 8. A method according to claim 7, wherein the control signals are test mode select (TMS), test clock (TCK), test data input (TDI) and test data output (TDO), and are conveyed by a test bus to all of the integrated circuits.
 - 9. A method according to any one of the preceding claims wherein the microprocessor is a microcontroller.
- 25 10. A method according to claim 9 wherein the microcontroller is used in a single chip microcomputer mode.

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